

Diode, Hochsetzsteller / Diode, Boost

Höchstzulässige Werte / Maximum Rated Values

Periodische Spitzensperrspannung Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
Implementierter Durchlassstrom Implemented forward current		I_{FN}	30	A
Dauergleichstrom Continuous DC forward current		I_F	25	A
Periodischer Spitzenstrom Repetitive peak forward current	$t_p = 1\text{ ms}$	I_{FRM}	60	A
Grenzlastintegral I^2t - value	$V_R = 0\text{ V}, t_p = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$ $V_R = 0\text{ V}, t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I^2t	88,4 66,0	A^2s A^2s

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Durchlassspannung Forward voltage	$I_F = 25\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	V_F	1,32	1,85	V
	$I_F = 25\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 125^{\circ}\text{C}$		1,55		V
	$I_F = 25\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 150^{\circ}\text{C}$		1,70		V
Rückstromspitze Peak reverse recovery current	$I_F = 25\text{ A}, -di_F/dt = 880\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	I_{RM}	16,4		A
		$T_{vj} = 125^{\circ}\text{C}$		16,4		A
		$T_{vj} = 150^{\circ}\text{C}$		16,4		A
Sperrverzögerungsladung Recovered charge	$I_F = 25\text{ A}, -di_F/dt = 880\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	Q_r	0,74		μC
		$T_{vj} = 125^{\circ}\text{C}$		0,74		μC
		$T_{vj} = 150^{\circ}\text{C}$		0,74		μC
Abschaltenergie pro Puls Reverse recovery energy	$I_F = 25\text{ A}, -di_F/dt = 880\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	E_{rec}	0,249		mJ
		$T_{vj} = 125^{\circ}\text{C}$		0,249		mJ
		$T_{vj} = 150^{\circ}\text{C}$		0,249		mJ
Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink	pro Diode / per diode	R_{thJH}		0,894		K/W
Temperatur im Schaltbetrieb Temperature under switching conditions		$T_{vj\text{ op}}$	-40		150	$^{\circ}\text{C}$

Bypass-Diode / Bypass-Diode

Höchstzulässige Werte / Maximum Rated Values

Periodische Spitzensperrspannung Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
Durchlassstrom Grenzeffektivwert pro Chip Maximum RMS forward current per chip	$T_H = 75^{\circ}\text{C}$	I_{FRMSM}	50	A
Gleichrichter Ausgang Grenzeffektivstrom Maximum RMS current at rectifier output	$T_H = 75^{\circ}\text{C}$	I_{RMSM}	50	A
Stoßstrom Grenzwert Surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$	I_{FSM}	1070	A
	$t_p = 10\text{ ms}, T_{vj} = 110^{\circ}\text{C}$		957	A
Grenzlastintegral I^2t - value	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$	I^2t	5770	A^2s
	$t_p = 10\text{ ms}, T_{vj} = 110^{\circ}\text{C}$		4580	A^2s

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Durchlassspannung Forward voltage	$T_{vj} = 150^{\circ}\text{C}, I_F = 45\text{ A}$	V_F		0,85		V
Sperrstrom Reverse current	$T_{vj} = 150^{\circ}\text{C}, V_R = 1200\text{ V}$	I_R		1,00		mA
Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink	pro Diode / per diode	R_{thJH}		0,870		K/W
Temperatur im Schaltbetrieb Temperature under switching conditions		$T_{vj\text{ op}}$	-40		110	$^{\circ}\text{C}$

Verpolschutz Diode A / Inverse-polarity protection diode A

Höchstzulässige Werte / Maximum Rated Values

Periodische Spitzensperrenspernung Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
Durchlassstrom Grenzeffektivwert pro Chip Maximum RMS forward current per chip	$T_H = 70^{\circ}\text{C}$	I_{FRMSM}	30	A
Gleichrichter Ausgang Grenzeffektivstrom Maximum RMS current at rectifier output	$T_H = 70^{\circ}\text{C}$	I_{RMSM}	30	A
Stoßstrom Grenzwert Surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10\text{ ms}, T_{vj} = 110^{\circ}\text{C}$	I_{FSM}	378 326	A A
Grenzlastintegral I^2t - value	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10\text{ ms}, T_{vj} = 110^{\circ}\text{C}$	I^2t	714 531	A^2s A^2s

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Durchlassspannung Forward voltage	$T_{vj} = 150^{\circ}\text{C}, I_F = 15\text{ A}$	V_F		0,89		V
Sperrstrom Reverse current	$T_{vj} = 150^{\circ}\text{C}, V_R = 1200\text{ V}$	I_R		1,00		mA
Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink	pro Diode / per diode	R_{thJH}		1,31		K/W
Temperatur im Schaltbetrieb Temperature under switching conditions		$T_{vj\text{ op}}$	-40		110	$^{\circ}\text{C}$

NTC-Widerstand / NTC-Thermistor

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Nennwiderstand Rated resistance	$T_{NTC} = 25^{\circ}\text{C}$	R_{25}		5,00		k Ω
Abweichung von R100 Deviation of R100	$T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493\ \Omega$	$\Delta R/R$	-5		5	%
Verlustleistung Power dissipation	$T_{NTC} = 25^{\circ}\text{C}$	P_{25}			20,0	mW
B-Wert B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/50}$		3375		K
B-Wert B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/80}$		3411		K
B-Wert B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/100}$		3433		K

Angaben gemäß gültiger Application Note.
Specification according to the valid application note.